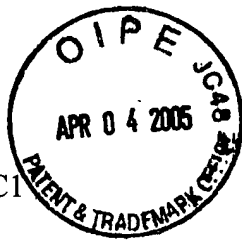


USFMCR.134C1



PATENT

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant : Johnson, et al.  
Appl. No. : 10/802,691  
Filed : March 16, 2004  
For : HIGH SOLIDS MODULE  
Examiner : Drodge, J. W.  
Group Art Unit : 1723

**CERTIFICATE OF MAILING**

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on

March 31, 2005

(Date)

Rose M. Thiessen, Reg. No. 40,202

**AMENDMENT**

**Mail Stop Amendment**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In response to the Office Action mailed December 23, 2004, Applicants respectfully request that the Examiner enter the following amendments and consider the following remarks.

**Amendments to the Claims** are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 5 of this paper.